

# BGSA11GN10

# Dual Single Pole Single Throw Antenna Tuning Switch

### Features

- Designed for high linearity and high RF voltage tuning applications
- Multiple selectable switch configurations: Each throw directly and independently controlled
- Low R<sub>ON</sub> resistance of 1.0 Ω at each port in ON state, 0.5 Ω using both SPST in parallel
- Low  $C_{OFF}$  capacitance of 250 fF at each port in OFF state
- High bidirectional RF operating voltage of 36 V in OFF state
- Low harmonic generation
- 2 GPIO pins control interface
- Supply voltage range: 1.65 to 3.6 V
- No RF parameter change within supply voltage range
- Small form factor 1.1 mm x 1.5 mm (MSL1, 260°C per JEDEC J-STD-020)
- RoHS and WEEE compliant package

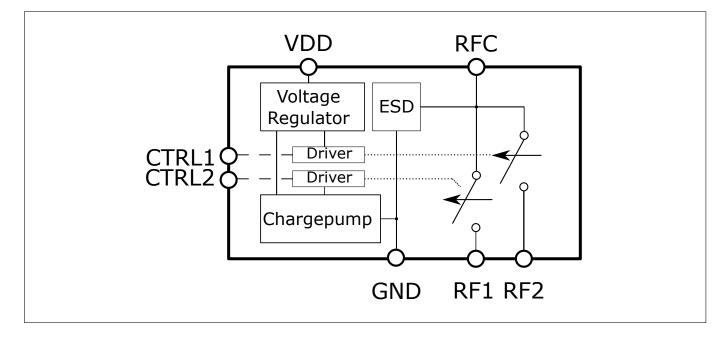
### **Potential Applications**

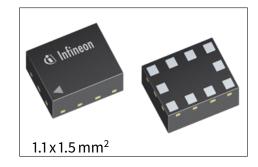
- Impedance Tuning
- Antenna Tuning
- Inductance Tuning
- Tunable Filters

### **Product Validation**

Qualified for industrial applications according to the relevant tests of JEDEC47/20/22.

### Block Diagram





# BGSA11GN10

### Dual Single Pole Single Throw Antenna Tuning Switch

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# **Table of Contents**

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#### Features

### **1 Features**

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### Description

The BGSA11GN10 is a Dual Single Pole Single Throw (SPST) RF antenna aperture switch optimized for low  $C_{OFF}$  enabling applications up to 6.0 GHz. This single supply chip integrates on-chip CMOS logic driven by a simple, single-pin CMOS or TTL compatible control input signal. Unlike GaAs technology, the 0.1dB compression point exceeds the switch maximum input power level, resulting in linear performance at all signal levels and external DC blocking capacitors at the RF ports are only required if DC voltage is applied externally. Due to its very high RF voltage ruggedness it is suited for switching any reactive devices such as inductors and capacitors in RF matching circuits without significant losses in quality factors.



Product Name	Marking	Package
BGSA11GN10	11	TSNP-10-1



**Maximum Ratings** 

### 2 Maximum Ratings

Parameter	Symbol		Value	es	Unit	Note / Test Condition	
		Min.	Тур.	Max.	1		
Frequency Range	f	0.1	_	-	GHz	1)	
Supply voltage <sup>2)</sup>	V <sub>DD</sub>	-0.5	-	3.6	V	Only for infrequent and short duration time periods	
Storage temperature range	T <sub>STG</sub>	-55	-	150	°C	-	
RF input power	P <sub>RF_max</sub>	-	_	39	dBm	Pulsed RF input power, duty cycle of 25% with T_period= 4620 μs, ON-state, setup as of Fig. 1	
RF voltage	V <sub>RF_max</sub>	-	-	48	V	Short term peaks (1µs, duty cy- cle 0.1%), Isolation mode, test setup acc. Fig. 2 / Fig. 3 and exceeding typical linearity, <i>R</i> <sub>ON</sub> and <i>C</i> <sub>OFF</sub> parameters	
ESD capability, CDM <sup>3)</sup>	V <sub>ESD<sub>CDM</sub></sub>	-1	-	+1	kV		
ESD capability, HBM <sup>4)</sup>	V <sub>ESD<sub>HBM</sub></sub>	-1	_	+1	kV		
ESD capability, system level (RF port) <sup>5)</sup>	V <sub>ESDANT</sub>	-8	-	+8	kV	RF vs system GND, with 27 nH shunt inductor	
Junction temperature	TJ	-	_	125	°C	-	
Thermal resistance junction - soldering point	R <sub>thJS</sub>	-	-	45	K/W	-	
Maximum DC-voltage on RF-Ports and RF- Ground	V <sub>RFDC</sub>	0	-	0	V	No DC voltages allowed on RF- Ports	
Control Voltage Levels	V <sub>Ctrlx</sub>	-0.7	-	V <sub>DD</sub> +0.7 (max. 3.6)	V	-	
Moisture Sensitivity Level	MSL	_	1	-		-	

#### **Table 1: Maximum Ratings, Table I** at $T_A = 25$ °C, unless otherwise specified

<sup>1)</sup> Switch has a low-pass response. For higher frequencies, losses have to be considered for their impact on thermal heating. The DC voltage at RF ports V<sub>RFDC</sub> has to be 0 V.

<sup>2)</sup> Note: Consider potential ripple voltages on top of  $V_{IO}$ . Including RF ripple,  $V_{IO}$  must not exceed the maximum ratings:  $V_{Ctrl} = V_{DC} + V_{Ripple}$ .

<sup>3)</sup> Field-Induced Charged-Device Model ANSI/ESDA/JEDEC JS-002. Simulates charging/discharging events that occur in production equipment and processes. Potential for CDM ESD events occurs whenever there is metal-to-metal contact in manufacturing.

 $^{4)}$  Human Body Model ANSI/ESDA/JEDEC JS-001 (R =  $1.5~{\rm k}\Omega,$  C =  $100~{\rm pF}).$ 

<sup>5)</sup> IEC 61000-4-2 ( $R = 330 \Omega$ , C = 150 pF), contact discharge.

Warning: Stresses above the max. values listed here may cause permanent damage to the device. Maximum ratings are absolute ratings; exceeding only one of these values may cause irreversible damage to the integrated circuit. Exposure to conditions at or below absolute maximum rating but above the specified maximum operation conditions may affect device reliability and life time. Functionality of the device might not be given under these conditions.



#### **Maximum Ratings**

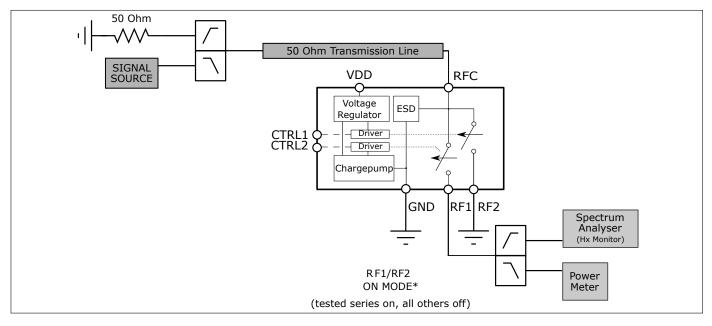
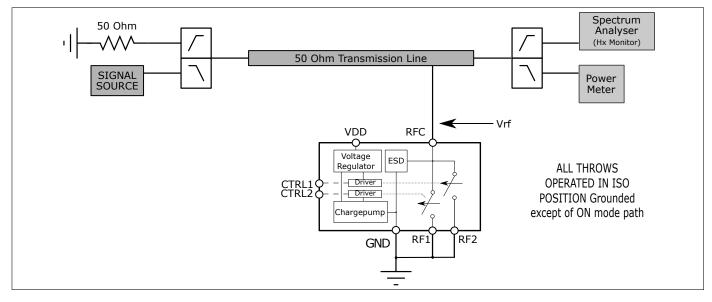


Figure 1: RF operating and Harmonics generation measurement configuration - RFx ON mode







**DC Characteristics** 

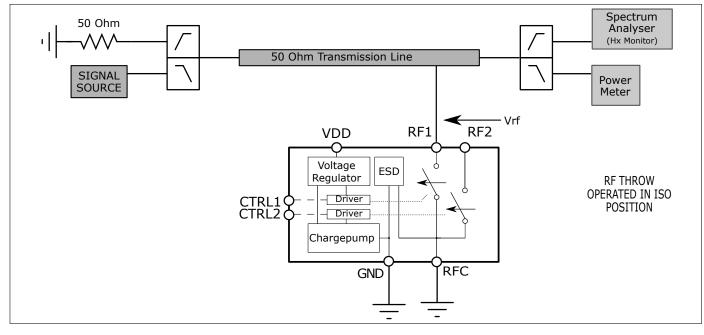


Figure 3: RF operating voltage measurement configuration - OFF mode at RFx

# **3 DC Characteristics**

<b>Table 2: DC Characteristics</b> at $T_A = -40 \degree C$ to	o 85 °C
--	---------

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Тур.	Max.		
Supply voltage	V <sub>DD</sub>	1.65	2.8	3.6	V	-
Supply current	I <sub>DD</sub>	-	80	150	μA	-
Control voltage low	V <sub>Ctrl,low</sub>	0	-	0.45	V	-
Control voltage high	V <sub>Ctrl,high</sub>	1.2	1.8	2.85	V	V <sub>Ctrl,high</sub> < V <sub>DD</sub>
Control current low	I <sub>Ctrl,low</sub>	-1	0	1	μA	-
Control current high	I <sub>Ctrl,high</sub>	-1	0	1	μA	V <sub>Ctrl,high</sub> < V <sub>DD</sub>
Ambient temperature	T <sub>A</sub>	-40	25	85	°C	-
RF switching time	t <sub>ST</sub>	2	5	7	μs	$P_{IN} = 0 \text{ dBm}, Z_0 = 50 \Omega,$
						$T_A = -40 ^{\circ}\text{C} + 85 ^{\circ}\text{C}$
						$V_{DD} = 1.65 - 3.6 V$
Startup time	t <sub>Pup</sub>	-	20	30	μs	Refering Fig. 4 and Fig. 5



### **DC Characteristics**

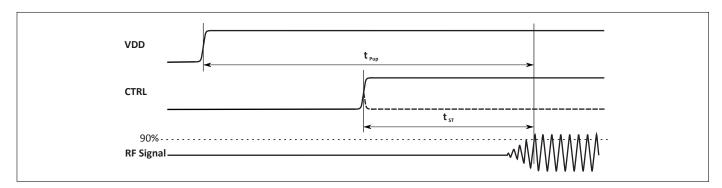


Figure 4: Switching Time Definition

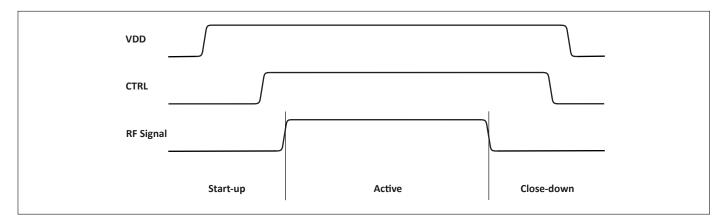


Figure 5: Timing of Control and RF signals for valid operation



**RF Small Signal Characteristics** 

# 4 RF Small Signal Characteristics

#### Table 3: RF small signal specifications

Parameter	Symbol		Values			Note / Test Condition	
		Min.	Тур.	Max.			
Frequency range	f	0.1	-	6.0	GHz	-	
Switch ON resistance	R <sub>ON</sub>	0.7	1.0	1.5	Ω	RFx to RFC	
Switch OFF capacitance	C <sub>OFF</sub>	200	250	350	fF	RFx to RFC	
Insertion Loss (1,2,3)		-					
824 - 960 MHz		0.10	0.19	0.29	dB	$V_{DD} = 1.8 - 3.6 V$ ,	
1710 - 1980 MHz		0.24	0.34	0.43	dB	$T_{A} = -40 ^{\circ}\text{C} + 85 ^{\circ}\text{C},$	
1981 - 2169 MHz	IL	0.28	0.36	0.43	dB	$Z_0 = 50 \Omega,$	
2170 - 2690 MHz		0.29	0.5	0.69	dB	RF1 or RF2 switched to RFC	
Return Loss <sup>(1,2,3)</sup>		-			I		
All Ports @ 824 - 915 MHz	וח	20	25	30	dB	$V_{DD} = 1.8 - 3.6 V$ ,	
All Ports @ 1710 - 2169 MHz	— <i>RL</i>	16	18	20	dB	$T_{A} = -40 ^{\circ}\text{C} + 85 ^{\circ}\text{C},$	
All Ports @ 2170 - 2690 MHz		12	15	18	dB	$Z_0 = 50 \Omega$	
Isolation RFx to RFC <sup>(1,2,3)</sup>							
824 - 915 MHz		16	17	19	dB		
1710 - 1980 MHz	150	14	12	11	dB	$V_{DD} = 1.8 - 3.6 V,$ $T_A = -40 ^{\circ}\text{C} + 85 ^{\circ}\text{C},$	
1981 - 2169 MHz	— ISO	13	11	11	dB	,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	
2170 - 2690 MHz		9	10	11	dB	$-Z_0 = 50 \Omega$	
Isolation RFx to RFx <sup>(1,2,3)</sup>							
824 - 915 MHz		21	22	24	dB	$V_{DD} = 1.8 - 3.6 V$ ,	
1710 - 1980 MHz		16	17	18	dB	$T_{A} = -40 ^{\circ}\text{C} + 85 ^{\circ}\text{C},$	
1981 - 2169 MHz	— ISO	15	16	17	dB	$Z_0 = 50 \Omega$	
2170 - 2690 MHz		13	15	17	dB	20 - 50 32	

<sup>1)</sup> Valid for all RF power levels, no compression behavior <sup>2)</sup> Network analyser input power:  $P_{IN} = -20 \ dBm$ <sup>3)</sup>On application board without any matching components



RF large signal parameter

# 5 RF large signal parameter

#### Table 4: RF large signal specifications

Parameter	Symbol		Values		Unit	Note / Test Condition	
		Min.	Тур.	Max.			
RF operating voltage	V <sub>RF_peak</sub>	-	-	36	V		
Harmonic Generation up to 12.75 GI	<b>Iz</b> <sup>(1,2,3)</sup>		l			1	
All RF Ports - Second Order Harmon-	P <sub>H2</sub>	-	90	-	dBc	25 dBm, 50Ω, $f_0$ = 786 MHz	
ics							
All RF Ports - Third Order Harmonics	P <sub>H3</sub>	-	115	-	dBc	25 dBm, 50Ω, $f_0$ = 786 MHz	
All RF Ports - Second Order Harmon-	P <sub>H2</sub>	-	90	-	dBc	33 dBm, 50Ω, $f_0$ = 824 MHz	
ics							
All RF Ports - Third Order Harmonics	Рнз	-	110	-	dBc	33 dBm, 50Ω, $f_0$ = 824 MHz	
All RF Ports	P <sub>Hx</sub>	105	-	-	dBc	25 dBm, 50Ω, CW mode	
Intermodulation Distortion IMD2 <sup>(1,2</sup>	,3)			·			
IIP2, low	IIP2,l	-	110	-	dBm		
IIP2, high	llP2,h	-	120	-	dBm	IIP2 conditions table 8	
Intermodulation Distortion IMD3 <sup>(1,2</sup>	,3)						
IIP3	IIP3	-	75	-	dBm	IIP3 conditions table 9	
SV LTE Intermodulation (1,2,3)							
IIP3,SVLTE	IIP3,SV	-	75	-	dBm	SV-LTE conditions table 10	

<sup>1)</sup> Terminating Port Impedance:  $Z_0 = 50 \Omega^{2}$  Supply Voltage:  $V_{DD} = 1.8 - 3.6 V^{3}$  On application board without any matching components

### Table 5: IIP2 conditions table

Band	In-Band Frequency	Blocker Frequency 1	Blocker Power 1	Blocker Frequency 2	Blocker Power 2
	[MHz]	[MHz]	[dBm]	[MHz]	[dBm]
Band 1 Low	2140	1950	20	190	-15
Band 1 High	2140	1950	20	4090	-15
Band 5 Low	881.5	836.5	20	45	-15
Band 5 High	881.5	836.5	20	1718	-15

#### Table 6: IIP3 conditions table

Band	In-Band Frequency	Blocker Frequency 1	Blocker Power 1	Blocker Frequency 2	Blocker Power 2
	[MHz]	[MHz]	[dBm]	[MHz]	[dBm]
Band 1	2140	1950	20	1760	-15
Band 5	881.5	836.5	20	791.5	-15

#### Table 7: SV-LTE conditions table

Band	In-Band Frequency	Blocker Frequency 1	Blocker Power 1	Blocker Frequency 2	Blocker Power 2
	[MHz]	[MHz]	[dBm]	[MHz]	[dBm]
Band 5	872	827	23	872	14
Band 13	747	786	23	747	14
Band 20	878	833	23	2544	14



Logic Truth Table

# 6 Logic Truth Table

#### Table 8: Logic Table

CTRL 1	CTRL 2	Mode RF1 to RFc	Mode RF2 to RFc2
0	0	OFF	OFF
0	1	OFF	ON
1	0	ON	OFF
1	1	ON	ON

CTRL1 and CTRL 2 can be connected together to control both switches at once. This enables the use of both SPSTs to reduce Ron by parallel switching

### BGSA11GN10

### Dual Single Pole Single Throw Antenna Tuning Switch



Application Information

# 7 Application Information

# Pin Configuration and Function

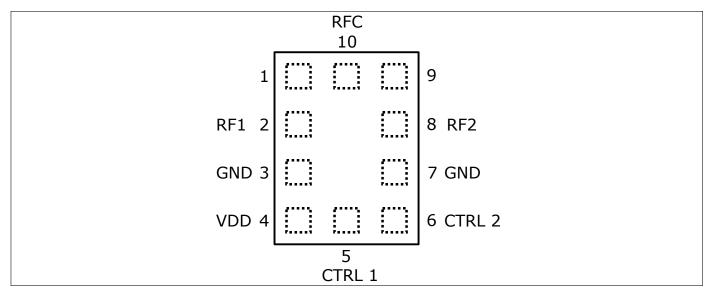


Figure 6: BGSA11GN10 Pin Configuration (top view)

#### Table 9: Pin Definition and Function

Pin No.	Name	Function
1	N.C.	Not connected
2	RF1	RF1 port
3	GND	Ground
4	VDD	Power Supply
5	CTRL1	GPIO digital control line
6	CTRL2	GPIO digital control line
7	GND	Ground
8	RF2	RF2 port
9	N.C.	Not connected
10	RFC	Common RF



#### **Application Examples**

# **8** Application Examples

The BGSA11GN10 is a dual single pole single throw (SPST) RF switch in a 1.05 mm x 1.55 mm TSNP-10-1 package. Both SPST can be controlled individually by the control placed next to each other. This solution allows the use of the device for several applications shown in Fig. 7:

- Low  $R_{ON} = 1\Omega$  SPST (a) or ultra low  $R_{ON} = 0.5\Omega$  SPST (b)
- Tuning with 2 reactive devices such as capacitors or inductors. (c)
- Combinations of above.

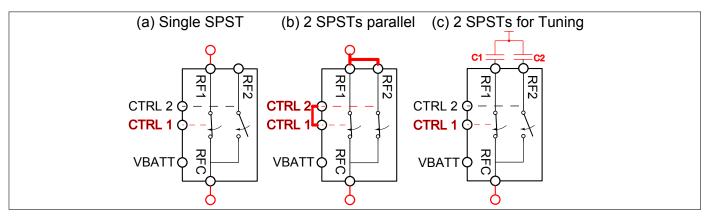


Figure 7: BGSA11GN10 realizable circuit configurations

### **Single SPST shunt operation**

The configuration (a) is used to obtain an  $R_{ON} = 1\Omega$  and  $C_{OFF} = 250 fF$ . It can be used for series and shunt configurations. Note, that for single SPST shunt configuration, is is better to connect RFC to GND to avoid additional capacitance contribution of the unused part RF2 to GND as shown in Fig. 8. For simplicity, connecting the unused RF and Control Pin can be connected to ground.

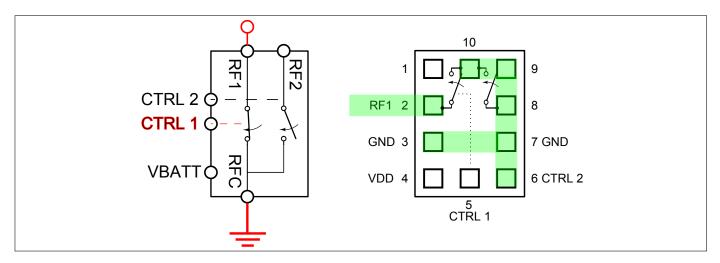


Figure 8: BGSA11GN10 single SPST shunt configuration



#### **Application Examples**

### Low R<sub>ON</sub> SPST shunt operation

For lowest possible  $R_{ON} = 0.5\Omega$  operation, it is required to connect the logic inputs CTRL 1 with CTRL 2 together and same for RF1 and RF2 as shown in Fig. 9

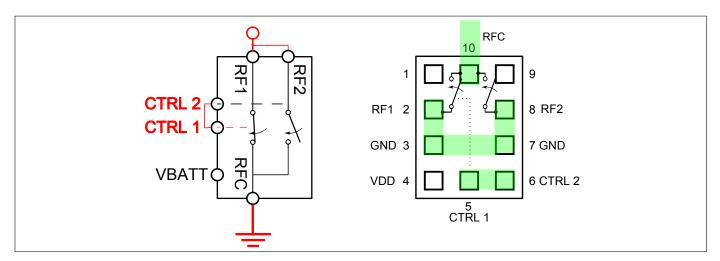


Figure 9: BGSA11GN10 low R<sub>ON</sub> SPST shunt configuration

### **Dual SPST for RF tuning**

The dual SPST can also be used for tuning applications, for example to tune capacitance or inductance. Fig. 10 shows as example a tunable capacitance with 4 steps by using 2 external MLCC capacitors. Note that the RF voltage should not exceed the specified 36 V over the switch device and also not for the used capacitor.

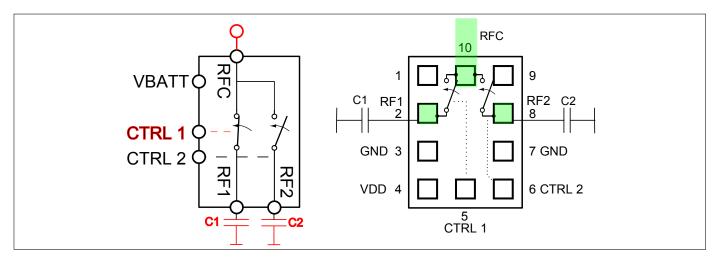


Figure 10: BGSA11GN10 as shunt capacitance tuning device

For example, resulting capacitances using C1 and C2 can be controlled as shown in table 10. Resulting Q factors can be calculated using the  $R_{ON}$  values using the equation  $Q = \frac{1}{\frac{U}{R_{ON}}}$  with  $\omega = 2\pi f$ . Same function can be realized also with inductors (Fig. 11) with  $Q = \frac{\omega L}{R_{ON}}$  in table 11.



Application Examples

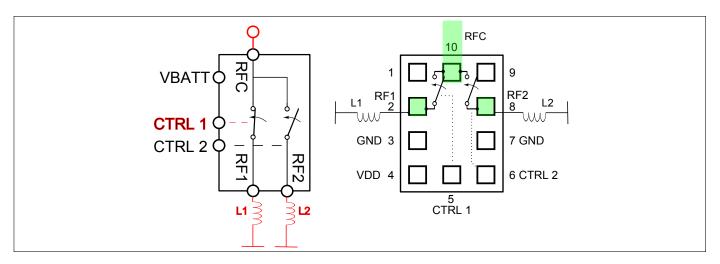


Figure 11: BGSA11GN10	as shunt inductance	tuning device
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#### Table 10: Logic Table

CTRL 1	CTRL 2	Mode RF1 to RFc	Mode RF2 to RFc	Capacitance	R <sub>ON</sub>
0	0	OFF	OFF	500 fF	500 kΩ
0	1	OFF	ON	250 fF + C2	1Ω
1	0	ON	OFF	250 fF + C1	1Ω
1	1	ON	ON	C1 + C2	0,5Ω

#### Table 11: Logic Table

CTRL 1	CTRL 2	Mode RF1 to RFc	Mode RF2 to RFc	Inductance	R <sub>ON</sub>
0	0	OFF	OFF	-	500 kΩ
0	1	OFF	ON	L2	1Ω
1	0	ON	OFF	L1	1Ω
1	1	ON	ON	L1    L2	0,5Ω



Package Information

### 9 Package Information

#### Table 12: Mechanical Data

Parameter	Symbol	Value	Unit
X-Dimension	X	$1.1\pm0.05$	mm
Y-Dimension	Y	$1.5\pm0.05$	mm
Size	Size	2.25	mm <sup>2</sup>
Height	Н	0.375 +0.025/-0.015	mm

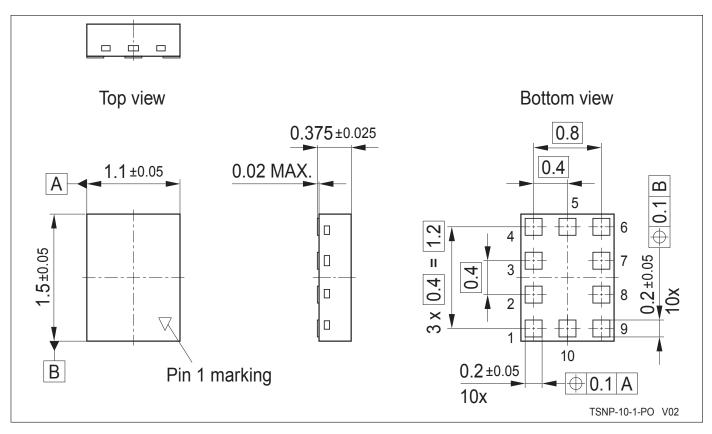


Figure 12: TSNP-10-1 Package Outline (top, side and bottom views)

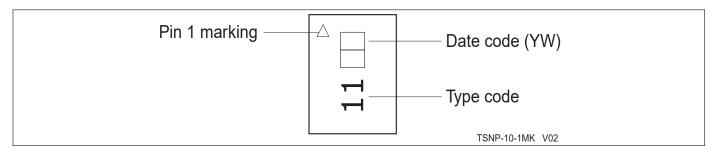


Figure 13: TSNP10-1 Marking Specification (top view): Date code digits Y and W defined in Table 13/14



#### Package Information



Year	"Y"	Year	"Y"	Year	"Y"
2010	0	2020	0	2030	0
2011	1	2021	1	2031	1
2012	2	2022	2	2032	2
2013	3	2023	3	2033	3
2014	4	2024	4	2034	4
2015	5	2025	5	2035	5
2016	6	2026	6	2036	6
2017	7	2027	7	2037	7
2018	8	2028	8	2038	8
2019	9	2029	9	2039	9

### Table 13: Year date code marking - digit "Y"

Table 14: Week date cod	e marking - digit "W"
-------------------------	-----------------------

Week	"W"								
1	A	12	Ν	23	4	34	h	45	v
2	В	13	Р	24	5	35	j	46	x
3	с	14	Q	25	6	36	k	47	у
4	D	15	R	26	7	37	ι	48	z
5	E	16	S	27	а	38	n	49	8
6	F	17	Т	28	b	39	р	50	9
7	G	18	U	29	с	40	q	51	2
8	н	19	V	30	d	41	r	52	3
9	J	20	W	31	e	42	s	53	м
10	к	21	Y	32	f	43	t		
11	L	22	Z	33	g	44	u		



### Package Information

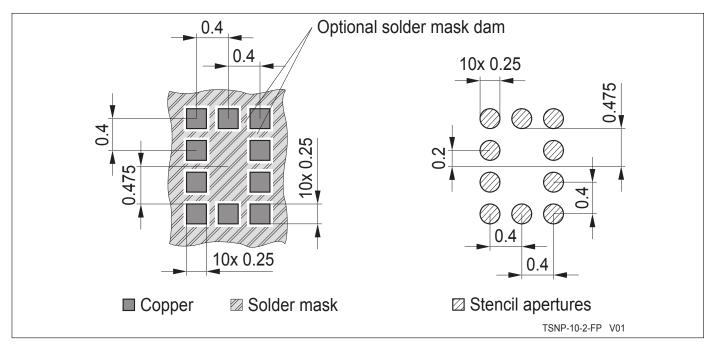


Figure 14: Land pattern and stencil mask (TSNP-10-1)

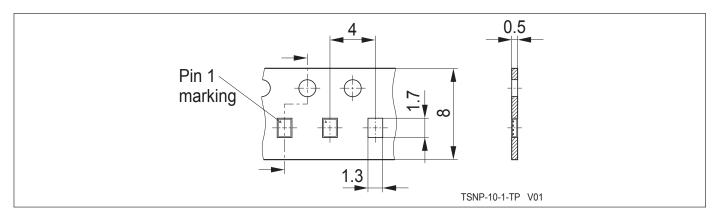


Figure 15: Carrier Tape (TSNP-10-1)

Revision History				
Creation of docum	ent Revision 3.2, 2020-07-08			
Page or Item	Subjects (major changes since previous revision)			
5	Typo at max. control current high corrected			

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Edition 2020-07-08 Published by Infineon Technologies AG 81726 Munich, Germany

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 BGS14PN10E6327XTSA1
 SKY12213-478LF

 SKY13404-466LF
 MASW-011060-TR0500
 SKYA21024
 SKY13319-374LF
 BGS14PN10E6327XTSA1
 SKY12213-478LF